

# Medical Grade Silicon Capacitor MGSC 0605 100nF BV30



Rev. 2.01

## General description

The 100nF Medical Grade Silicon Capacitor targets filtering and decoupling in medical high reliability applications with significant space constraints.

Products have been tested specifically for medical applications and manufacturing is done in our Murata IATF 16949 certified facility.

A final specific electrical test is performed on 100% of our Medical grade capacitors.

100nF MGS Capacitor is using our PICS3-HV process which allows it to operate under 16V at 150°C

## Key features

- Temperature stability (up to 150°C)
- Very low profile (100µm)
- Negligible capacitance loss through ageing
- Small size 1.59x1.32mm +/-20µm (0605)
- Low leakage current
- High reliability
- Compatible with high temperature cycling during manufacturing operations (exceeding 300°C)
- Compatible with embedded process. Please refer to the specific Application Note "Embedded Silicon Capacitor"

## Key applications

- Any demanding applications, such as industrial medical, implantable medical and healthcare
- Increase battery longevity
- Supply decoupling / filtering of active device



**Functional diagram**

The next figure provides implementation set-up diagram.

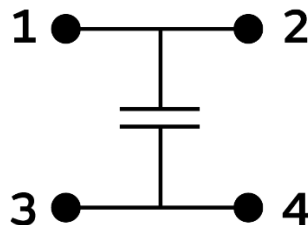


Figure 1 Block Diagram

**Electrical performances**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
C	Capacitance value	@25°C	-	100	-	nF
$\Delta C_P^{(1)}$	Capacitance tolerance	@25°C	-15	-	+15	%
T <sub>OP</sub>	Operating temperature		-55		+150	°C
T <sub>STG</sub> <sup>(2)</sup>	Storage temperature		-10	-	+35	°C
$\Delta C_T$	Capacitance temperature variation	-55°C to 150°C		76		ppm/K
RV <sub>DC</sub> <sup>(3)</sup>	Rated voltage		-	10	16 <sup>(4)</sup>	V <sub>DC</sub>
$\Delta C_{RVDC}$	Capacitance voltage variation	From 0V to 10V @25°C	-	-	-0.02	%/V <sub>DC</sub>
IR	Insulation resistor	@25°C, 16V, 120s	-	14	-	GΩ
ESR <sup>(5)</sup>	Equivalent Serial Resistor	@+25°C, shunt mode, wirebonded on a board with SMA connectors	-	0.2	-	Ω
ESD	HBM stress <sup>(6)</sup>	(100pF/1.5kOhms) max +/-8kV Level H3B	8	-	-	kV

Table 1 - 100nF MGS capacitor performances

<sup>(1)</sup>: other tolerance available upon request

<sup>(2)</sup>: without packaging. Please refer to the application note "MIS storage and shelf-life conditions"

<sup>(3)</sup>: Lifetime is voltage and temperature dependent, please refer to application note 'Lifetime of 3D capacitors'

<sup>(4)</sup>: 10 years of intrinsic lifetime prediction at 100°C continuous operation

<sup>(5)</sup>: Estimate

<sup>(6)</sup>: please refer to application note 'ESD Challenge in 3D Murata Integrated Passive technology'



**Pinning definition**

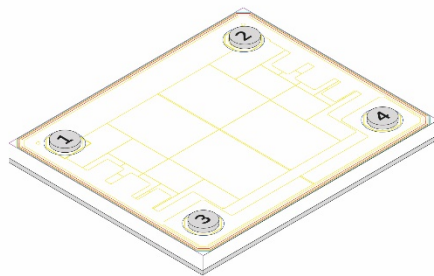


Figure 2 Pinning definition

pin #	Symbol	Coordinates X / Y
1	Signal	-580 / 445
2	Signal	580 / 445
3	Signal	-580 / -445
4	Signal	580 / -445

Table 2 - Pinning description. Reference (0,0) located at the center of the die.

Parts should be glued with non-conductive paste. If conductive glue is used on the backside of the silicon capacitor, it's strongly recommended to avoid connecting the backside to electrical signal. If backside is connected to electrical signal, this signal will absolutely be the same as pads 3-4.

**Ordering Information**

Regardless of packaging, Murata Integrated Passive Devices delivers products with AQL level II (0.65).

Part number (15NC)	Package		
	Packaging	Finishing	Description
935181733610-T3A	T&R**	Al*	0605 -100nF – BV30 – T&R 1000pcs, Al pads
935181733610-T3C	T&R**	Cu	0605 -100nF – BV30 – T&R 1000pcs, Copper 5µm min

Table 3 - Packaging and ordering information

(\*)AlSiCu  
 (\*\*) missing capacitors can reach 0.5%



**Pad Metallization**

Silicon dies are not sensitive to humidity, please refer to application note 'Products Storage Conditions and Shelf Life'.

Wirebondable component with 2 pads on each terminal.

Pad finishing in Aluminum (3µm thickness), other finishing available on request such as copper, nickel or gold  
Metallization = Aluminum

**Material regulation**

This product is RoHS compliant at the time of publication. For further information about regulation compliancy, please ask your sales representative.

**Package outline**

This MGS Capacitor is delivered as a naked die, with 150 µm opening for contacts.

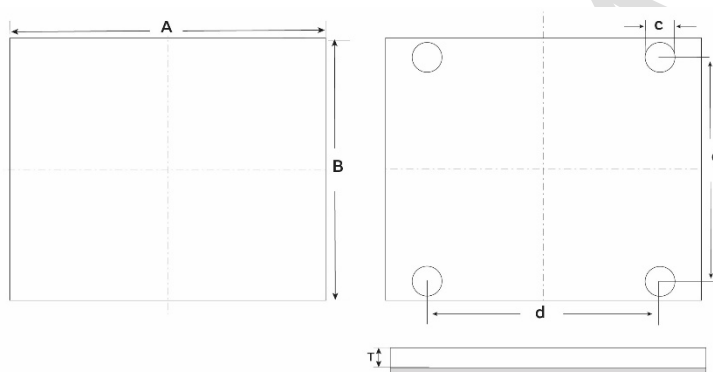


Figure 3 - Package outline drawing

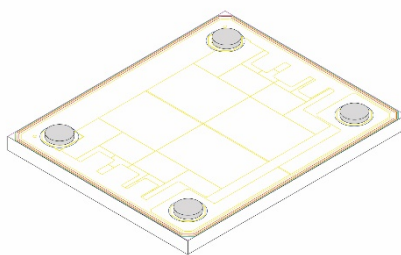


Figure 4 - Package isometric view

A (mm)	B (mm)	T (mm)	c (mm)	d (mm)	e (mm)
1.59 +/- 20µm	1.32 +/- 20µm	0.1 +/- 15µm	0.15	1.16	0.89

Table 4 - Dimensions and tolerances



**Assembly**

The attachment techniques recommended by Murata on the customer’s substrates are fully detailed in specific documents available on our website. To assure the correct use and proper functioning of Murata capacitors **please download the assembly instructions on <https://www.murata.com/en-us/products/capacitor/siliconcapacitors> and read them carefully.**



Figure 5 Scan this QR Code to access the Murata Silicon Capacitor web page

**Packaging format**

Please refer to application note ‘Products Storage Conditions and Shelf Life’.

**Tape and Reel:**

Dies are flipped in the tape cavity (bump down) with die ID located near the driving holes of the tape.

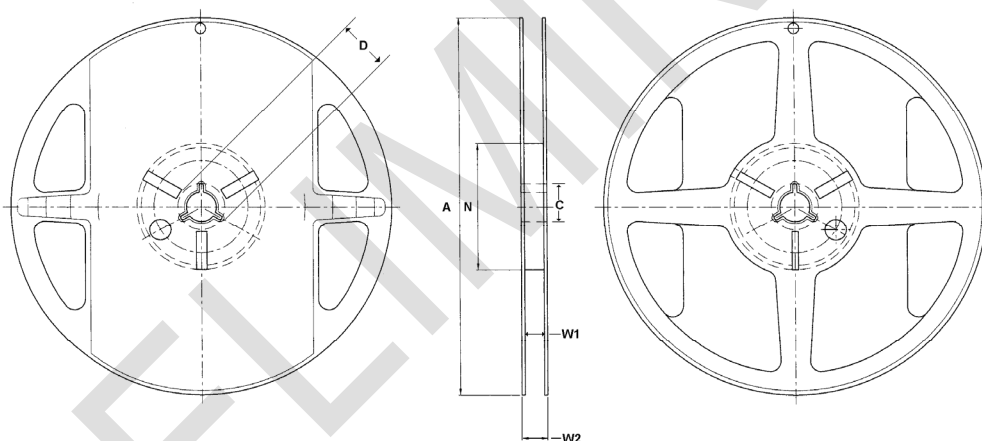


Figure 5 - Reel drawing

Tape Width	Diameter A	C	D	Hub N	W1	W2
8	178 (7 inches)	13.5	20.2	60	9	11.5

Table 5 – Reel dimensions (mm)

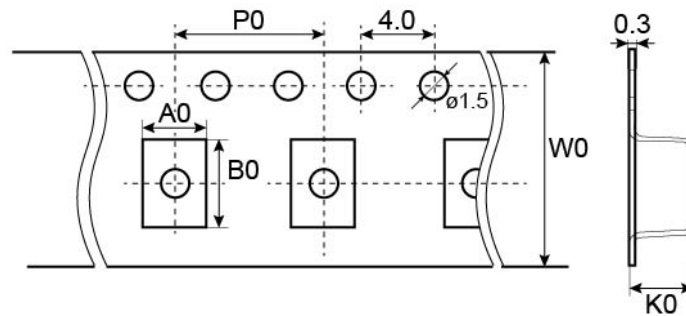


Figure 6 - Tape drawing

Cavity dimensions			Carrier tape width W0	Carrier tape pitch P0	Quantity per reel
Ao	Bo	Ko			
1.45	1.75	0.55	8	4	1000

Table 6 - Tape dimensions (mm)



## Definitions

### Data sheet status

Objective specification: This data sheet contains target or goal specifications for product development.

Preliminary specification: This data sheet contains preliminary data; supplementary data may be published later.

Product specification: This data sheet contains final product specifications.

### Limiting values

Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those given in the Electrical performances sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

### Application information

Where application information is given, it is advisory and does not form part of the specification.

## Revision history

Revision	Date	Description	Author
0.1	6/07/2020	Objective specifications	S. Leruez
2.01	24/11/2020	Template update – Statut update	C. Guezennec

## Disclaimer / Life support applications

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